

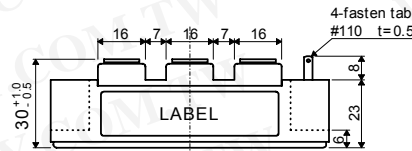
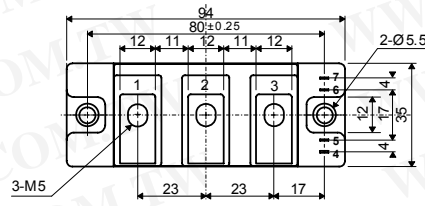
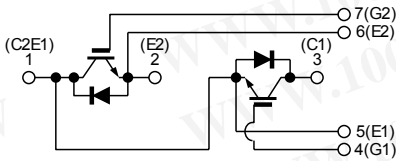
IGBT Module-Dual

75 A, 600V

PDMB75E6

□ 回路図 : CIRCUIT

□ 外形寸法図 : OUTLINE DRAWING



勝特力材料 886-3-5753170
 胜特力电子(上海) 86-21-34970699
 胜特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

Dimension: [mm]

□ 最大定格 : MAXIMUM RATINGS (T_c=25°C)

Item	Symbol	Rated Value	Unit
コレクタ・エミッタ間電圧 Collector-Emmitter Voltage	V _{CEs}	600	V
ゲート・エミッタ間電圧 Gate-Emmitter Voltage	V _{GES}	±20	V
コレクタ電流 Collector Current	DC	75	A
	1ms	150	
コレクタ損失 Collector Power Dissipation	P _C	320	W
接合温度 Junction Temperature Range	T _j	-40~+150	°C
保存温度 Storage Temperature Range	T _{stg}	-40~+125	°C
絶縁耐圧(Terminal to Base AC, 1 minute) Isolation Voltage	V _{ISO}	2,500	V (RMS)
締め付けトルク Mounting Torque	Module Base to Heatsink	2	N·m
	Busbar to Main Terminal	2 (20.4)	(kgf·cm)

□ 電気的特性 : ELECTRICAL CHARACTERISTICS (T_c=25°C)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
コレクタ遮断電流 Collector-Emmitter Cut-Off Current	I _{CEs}	V _{CE} =600V, V _{GE} =0V	-	-	1.0	mA
ゲート漏れ電流 Gate-Emmitter Leakage Current	I _{GES}	V _{GE} =±20V, V _{CE} =0V	-	-	1.0	μA
コレクタ・エミッタ間飽和電圧 Collector-Emmitter Saturation Voltage	V _{CE(sat)}	I _C =75A, V _{GE} =15V	-	2.1	2.6	V
ゲートしきい値電圧 Gate-Emmitter Threshold Voltage	V _{GE(th)}	V _{CE} =5V, I _C =75mA	4.0	-	8.0	V
入力容量 Input Capacitance	C _{ies}	V _{CE} =10V, V _{GE} =0V, f=1MHz	-	3,200	-	pF
スイッチング時間 Switching Time	上昇時間 Rise Time	V _{CC} =300V R _L =4.0Ω R _G =12.0Ω V _{GE} =±15V	-	0.15	0.30	μs
	ターンオン時間 Turn-on Time		-	0.25	0.40	
	下降時間 Fall Time		-	0.10	0.35	
	ターンオフ時間 Turn-off Time		-	0.35	0.70	

□ フリーホイールリングダイオードの特性 : FREE WHEELING DIODE RATINGS & CHARACTERISTICS (T_c=25°C)

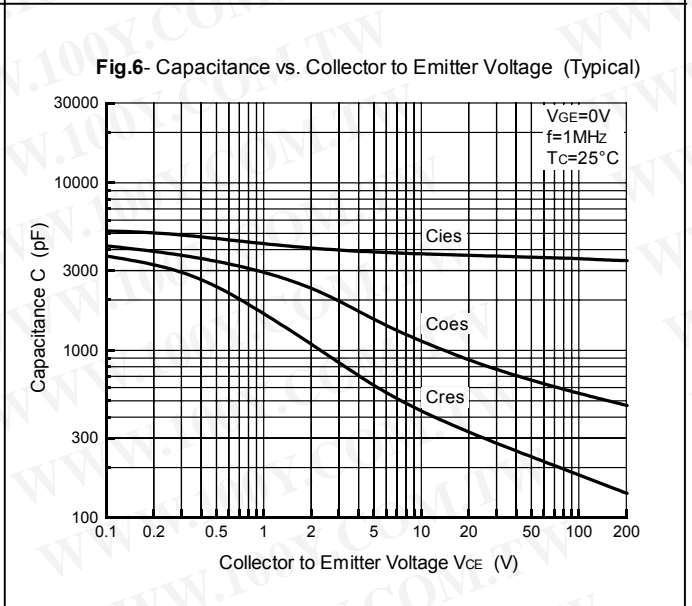
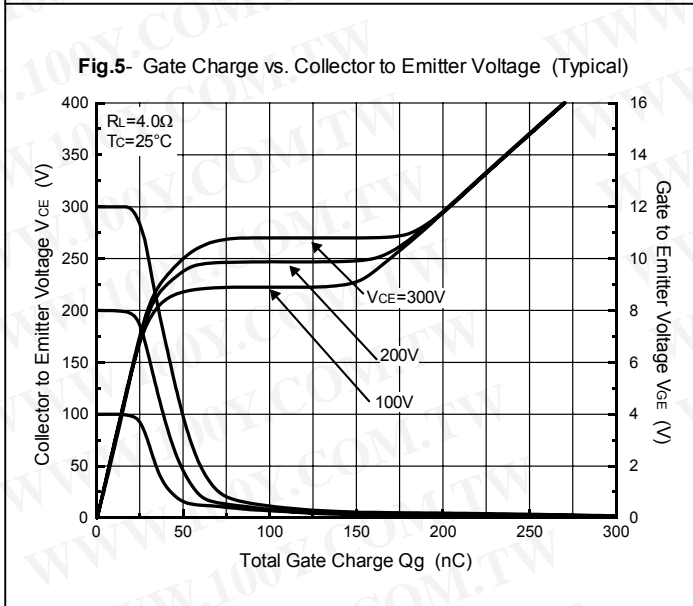
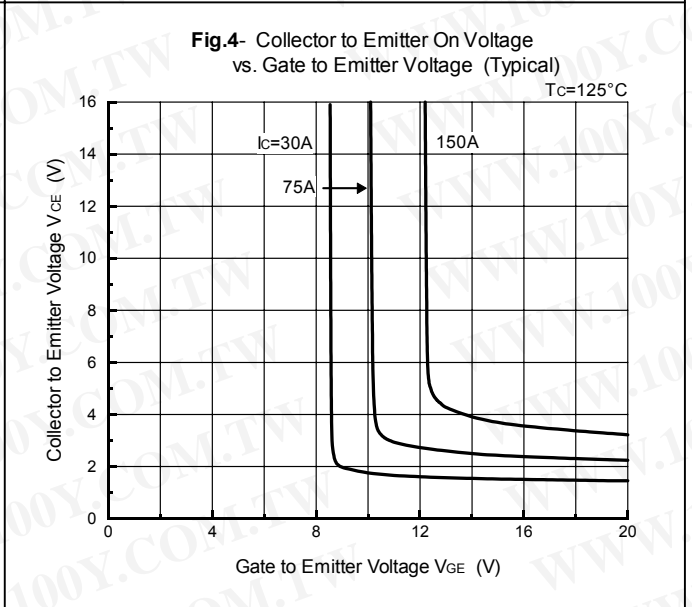
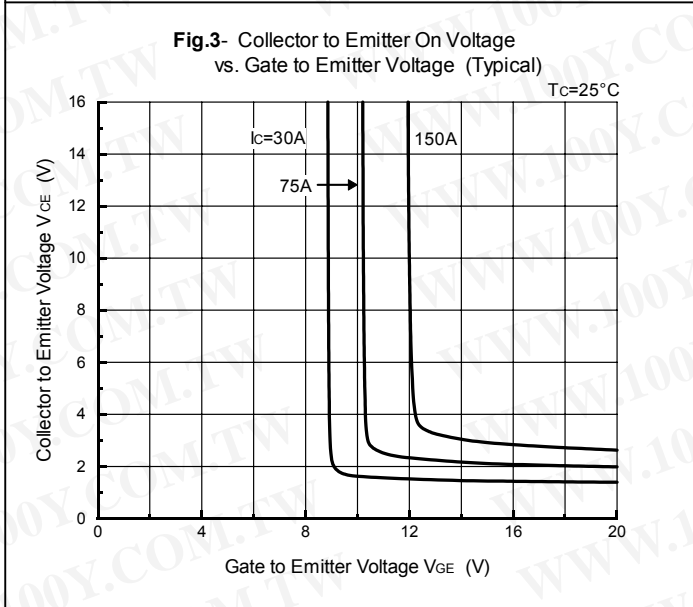
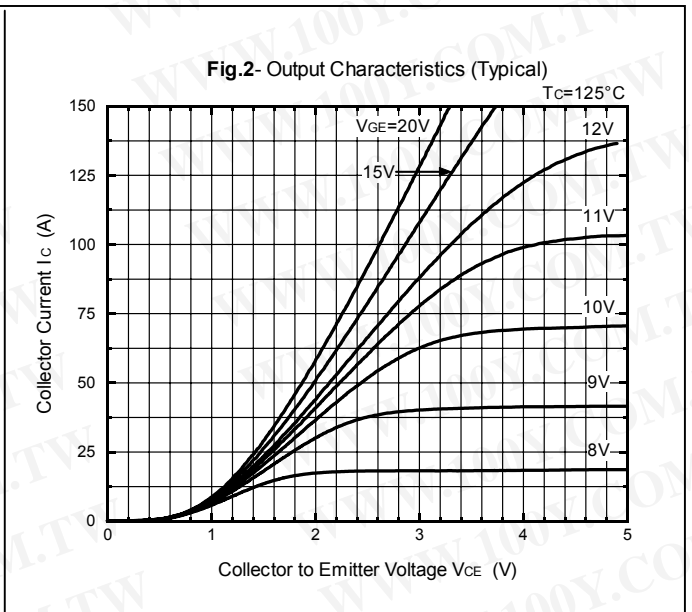
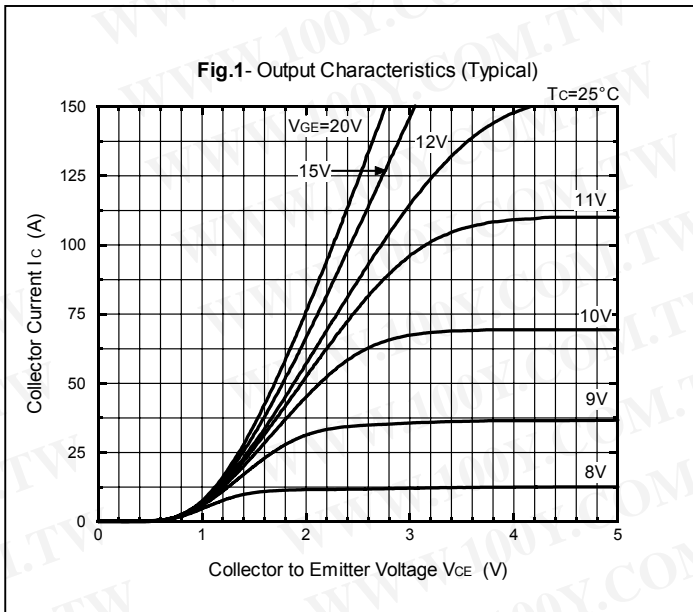
Item	Symbol	Rated Value	Unit
順電流 Forward Current	DC	75	A
	1ms	150	

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
順電圧 Peak Forward Voltage	V _F	I _F =75A, V _{GE} =0V	-	1.9	2.4	V
逆回復時間 Reverse Recovery Time	t _{rr}	I _F =75A, V _{GE} =-10V di/dt=150A/μs	-	0.15	0.25	μs

□ 熱的特性 : THERMAL CHARACTERISTICS

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
熱抵抗 Thermal Impedance	IGBT	Junction to Case (T _c 測定点チップ直下)	-	-	0.38	°C/W
	Diode		-	-	0.80	

P D M B 7 5 E 6



P D M B 7 5 E 6

Fig.7- Collector Current vs. Switching Time (Typical)

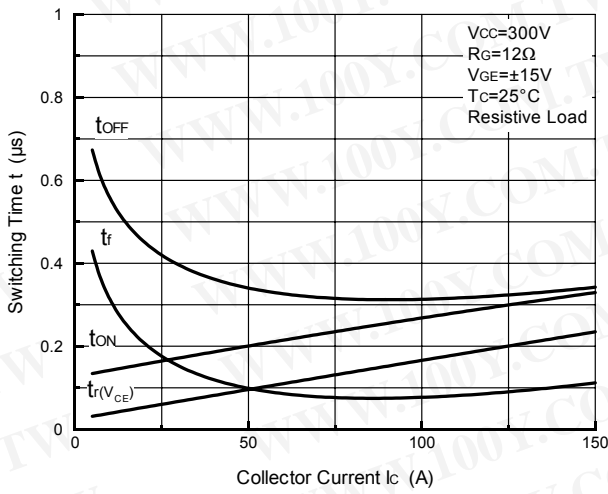


Fig.8- Series Gate Impedance vs. Switching Time (Typical)

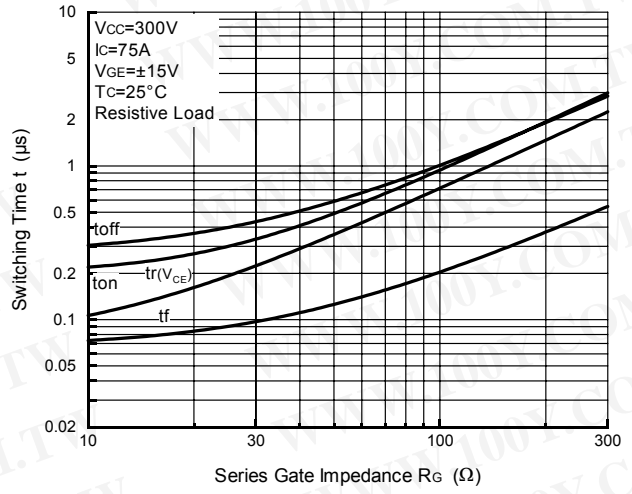


Fig.9- Collector Current vs. Switching Time

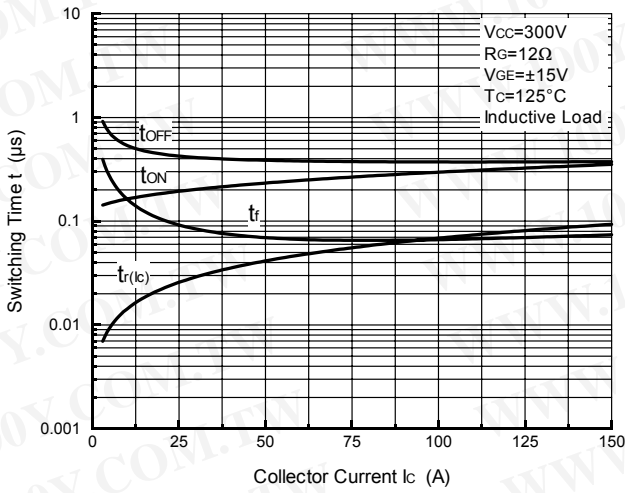


Fig.10- Series Gate Impedance vs. Switching Time

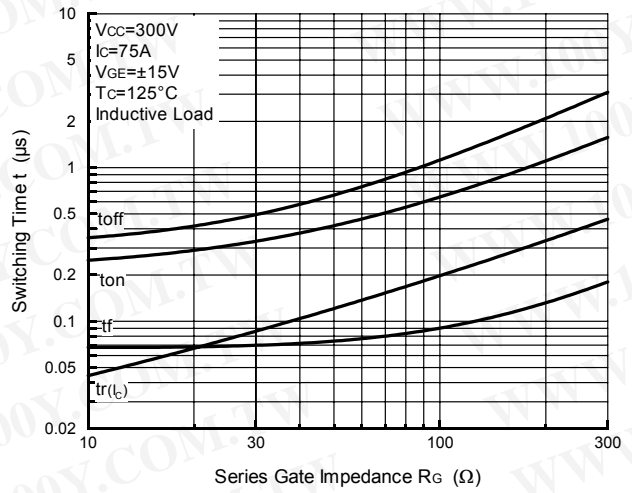


Fig.11- Collector Current vs. Switching Loss

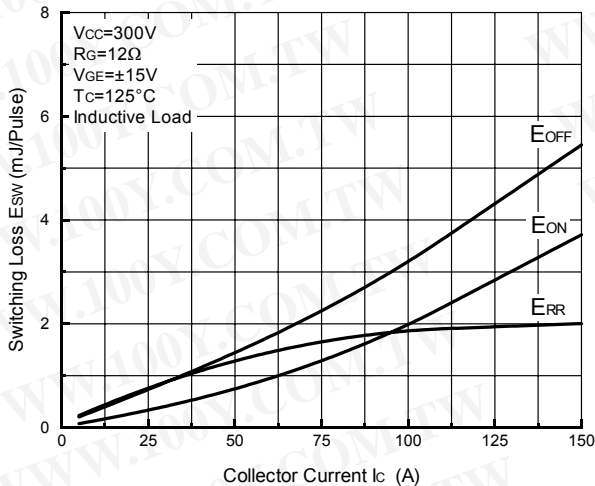
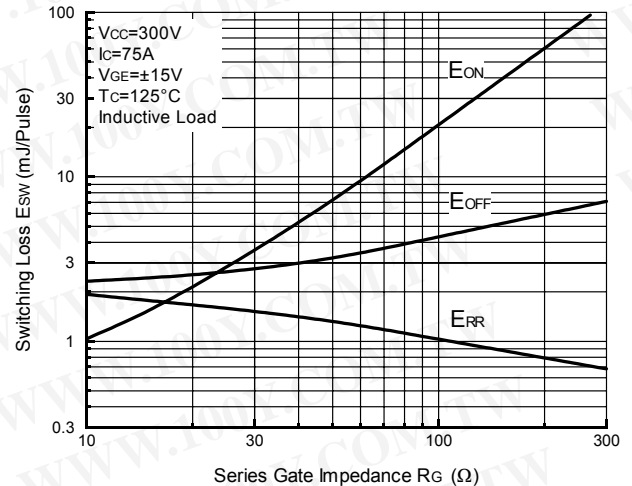


Fig.12- Series Gate Impedance vs. Switching Loss



P D M B 7 5 E 6

Fig.13- Forward Characteristics of Free Wheeling Diode (Typical)

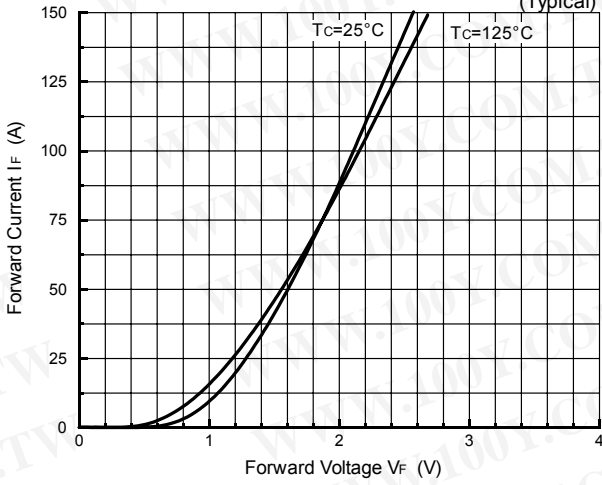


Fig.14- Reverse Recovery Characteristics (Typical)

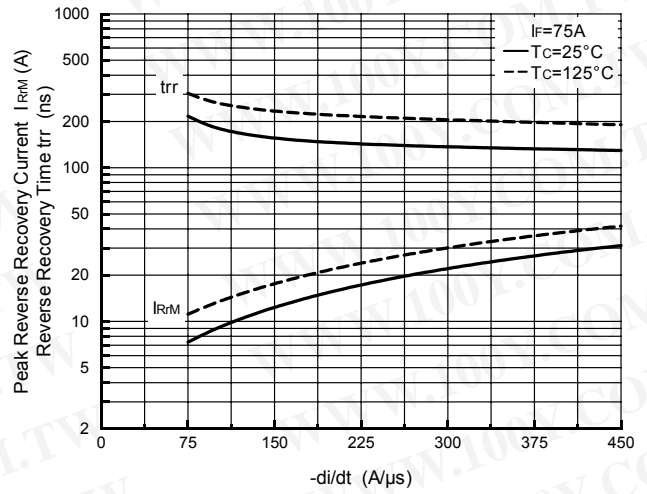


Fig.15- Reverse Bias Safe Operating Area

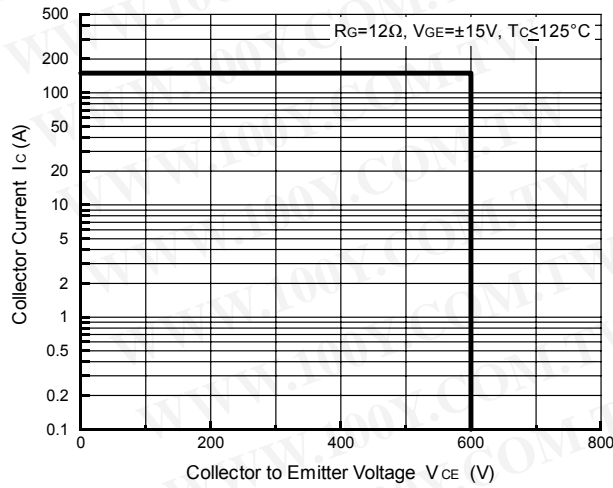


Fig.16- Transient Thermal Impedance

